PTO-1595 RECC	ET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
To the Honorable Commissioner of Patents and madernarks: Pl	lease record the attached original documents or copy thereof.
Name of conveying party(ies):	2 Name and address of receiving party(ies):
Dun-Nian Yaung Shou-Gwo Wuu Ho-Ching Chien Yi-Shing Chang	Taiwan Semiconductor Manufacturing Co. Ltd. No. 6. Li-Hsin Rd. 6 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3 Nature of conveyance: ■ Assignment □ Merger	Additional name(s) & address(es) attached □ Yes ☒ No
☐ Security Agreement ☐ Change of Name ☐ Other: Execution Date: Sept 25, 2003	
Application number(s) or patent number(s): If this document is being filed together with a new application A. Patent Application No(s).	n, the execution date of the application is: 09-25-03 B. Patent No(s)
Additional numbers at Name and address of party to whom correspondence concerning document should be mailed:	tached? □ Yes ☒ No 6 Total number of applications and patents involved:
RANDY W. TUNG Tung & Associates 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302	7 Total fee (37 CFR 3.41) \$40.00 □ Enclosed □ Authorized to charge credit card (w/filing fee)
22003 WABRHAM1 00000037 10701670 8021 40.00 DP	Deposit Account Number: 50-0484 (Attach duplicate copy of this page if paying by deposit account)
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9 Statement and signature. To the best of my knowledge and belief, the foregoing inform the original document. Randy W. Tung Name of Person Signing Registration No. 31,311	eation is true and correct and any attached copy is a true copy of Oct. 29, 2003 Date
Total number of pages including cover sheet, attachments, and document : 3 Commissioner for Patents P.O. Boy 1450	

11-14-2003

P.O. Box 1450 Alexandria, VA 22313-1450

PATENT REEL: 014685 FRAME: 0375

ASSIGNMENT

WHEREAS, we, <u>DUN-NIAN YAUNG, SHOU-GWO WUU, HO-CHING CHIEN</u> and YI-SHING CHANG, have invented certain improvements in

SENSOR ELEMENT HAVING ELEVATED DIODE

WITH SIDEWALL PASSIVATED BOTTOM ELECTRODE

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

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REEL: 014685 FRAME: 0376

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application and any divisional, continuation or continuation-in-part application thereof, and in and

to any reissue of any such patent, and in and to any patent applications which may be filed on said

invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention

in its own name or through its designees, including subsidiaries, related companies or assignees,

under the International Convention or otherwise, and we further agree to execute all papers,

including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

Slun- Man Yaung Shou-Gwo WUU

Shou-Gwo WUU

Ho-Ching Chien

YI-SHING Chang

YI-SHING CHANG

TUNG & ASSOCIATES 838 W. Long Lake Road **Suite 120**

Bloomfield Hills, Michigan 48302

RECORDED: 11/05/2003

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PATENT REEL: 014685 FRAME: 0377